AN26011A

LNA-IC for 800MHz / 450MHz Band Applications

FEATURES

 Low voltage oper 	ation	+2.80 V typ.						
 High gain 	15.0 dB typ.	fRX = 881.5 MHz						
	16.0 dB typ.	fRX = 450 MHz						
Low noise figure	1.40 dB typ.	fRX = 881.5 MHz						
	1.30 dB typ.	fRX = 450 MHz						
 Low distortion 								
(IIP3 +10 MHz offset)								
	+10.0 dBm typ.	fRX = 881.5 MHz						

DESCRIPTION

AN26011A is LNA-IC for 800MHz / 450MHz Band Applications. Realizing high performance by using 0.18 μm SiGeC Bi-CMOS process($f_T = 90$ GHz, $f_{max} = 140$ GHz). Low Gain mode is available, controlled by integrated

CMOS logic circuit.

Achieving miniaturization by using small size package.

+10.0 dBm typ. fRX= 450 MHz

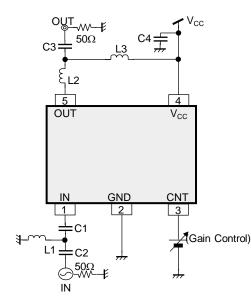
• 5 pin Plastic Small Surface Mount Package (SMINI Type)

APPLICATIONS

•Cellular Phone 800MHz / 450MHz Band Application

SIMPLIFIED APPLICATION

TOP VIEW



Components	Size	Value	Part Number	Vendor
L1	0603	12 nH	LQPT03TN12NH04	Murata
L2	0603	12 nH	LQPT03TN12NH04	Murata
L3	L3 0603		LQPT03TN10NH04	Murata
C1	0603	1000 pF	GRM033B11C102KD01	Murata
C2	0603	4.0 pF	GJM0332C1E4R0BB01D	Murata
C3	0603	4.0 pF	GJM0332C1E4R0BB01D	Murata
C4	0603	0.1 μF	GRM033B30J104KE18	Murata

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Note
Supply voltage	V _{cc}	3.6	V	*1
Supply current	I _{cc}	18	mA	_
Operating ambient temperature	ating ambient temperature T _{opr}		°C	*2
Operating junction temperature	T _j	-40 to +125	°C	*2
Storage temperature	T _{stg}	-55 to +125	°C	*2
	IN (Pin No.1)	_	V	*3
Input Voltage Range	CNT (Pin No.3)	– 0.3 to (V _{CC} +0.3)	V	*4
	OUT (Pin No.5)	– 0.3 to (V _{CC} +0.3)	V	*4
ESD	HBM (Human Body Model)	1500	V	_

Notes). This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating. This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range.

When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

*1:The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

*2:Except for the operating ambient temperature, operating junction temperature and storage temperature, all ratings are for $T_{2} = 25^{\circ}C$

all ratings are for Ta = 25°C.

*3:RF signal input pin. Do not apply DC. Do not apply more than 0 dBm to RF input.

*4:(Vcc + 0.3) V must not be exceeded 3.6 V.

POWER DISSIPATION RATING

PACKAGE	θ_{AE}	PD (Ta=25℃)	PD (Ta=70°C)
SSMINI-5DC	833°C/W	0.12W	0.066W

Note). For the actual usage, please refer to the PD-Ta characteristics diagram in the package specification, supply voltage, load and ambient temperature conditions to ensure that there is enough margin follow the power and the thermal design does not exceed the allowable value.



CAUTION

Although this has limited built-in ESD protection circuit, but permanent damage may occur on it. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage range	V _{cc}	2.65	2.8	2.95	V	*1

Note) *1: The values under the condition not exceeding the above absolute maximum ratings and the power dissipation

ELECRTRICAL CHARACTERISTICS

Note) $V_{CC} = 2.80 \text{ V}$, $T_a = 25^{\circ}\text{C}\pm2^{\circ}\text{C}$, unless otherwise specified. Performance based on application circuit 1 on page 11.

	Parameter	Symbol	Condition		Limits		Unit	Note
	Farameter	Symbol	Condition	Min	Тур	Max	Unit	Note
DC	DC electrical characteristics							
	Supply current (High Gain mode)	IccHS	V _{CC} current at High Gain mode. No input signal	_	11.5	14.5	mA	_
	Supply current (Low Gain mode)	IccLS	V _{CC} current at Low Gain mode. No input signal	_	0	10	μA	
	CNT current (High Gain mode)	IcntHS	Current at CNT Pin. Voltage at CNT Pin = 2.80 V	_	5	35	μA	
	CNT current (Low Gain mode)	IcntLS	Current at CNT Pin. Voltage at CNT Pin = 0 V	_	0	10	μA	_
	CNT voltage (High Gain mode)	VIHS	—	2.52		3.1	V	
	CNT voltage (Low Gain mode)	VILS	—		0	0.3	V	

ELECRTRICAL CHARACTERISTICS (continued)

Note) Vcc = 2.80 V,

Ta = $25^{\circ}C\pm 2^{\circ}C$, fRX = 881.5 MHz, PRX = -30 dBm, CW unless otherwise specified. Performance based on application circuit 1 on page 11.

	Parameter	Symbol	Condition		Limits		Unit	Note			
Faraneter		Symbol Condition		Min	Тур	Max	Onit	Note			
LN	LNA AC electrical characteristics (High Gain Mode)										
	Power Gain HG	GHS	_	13.0	15.0	17.0	dB	_			
	IIP3 +10 MHz offset	IIP3S	f1 = fRX + 10 MHz f2 = fRX + 20 MHz Input 2 signals (f1, f2)	6.0	10.0		dBm				
LN	LNA AC electrical characteristics (Low Gain Mode)										
	Power Gain LG	GLS	PRX = – 20 dBm	-5.0	-3.0	-1.5	dB	_			

APPLICATION INFORMATION

REFERENCE VALUES FOR DESIGN

Note) Vcc = 2.80 V

Ta = $25^{\circ}C\pm 2^{\circ}C$, fRXa = 869 MHz, 881.5 MHz, 894 MHz, PRXa = -30 dBm, CW unless otherwise specified. Performance based on application circuit 1 on page 11.

	Description		0	Refer	ence v	alues	Unit	Nexts
	Parameter	Symbol	Conditions	Min	Тур	Мах	Unit	Note
LNA	AC electrical characteristics	(High Gain	Mode)					
	Power Gain HG	GHa	_	13.0	15.0	17.0	dB	*1
	Noise Figure HG	NFHa	_	_	1.5	2.1	dB	*1,*2
	IIP3 +10 MHz offset HG	IIP3H1a	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz Input 2 signals (f1, f2)	6.0	10.0	_	dBm	*1
	IIP3 -10 MHz offset HG	IIP3H2a	f1 = fRXa - 10 MHz f2 = fRXa - 20 MHz Input 2 signals (f1, f2)	6.0	10.0	_	dBm	*1
	Input P1dB	IP1dBHa	—	-10.0	-6.0	_	dBm	*1
	Reverse Isolation HG	ISOHa	—		-22.0	-18.0	dB	*1
	Input Return Loss HG	S11Ha	_	5.5	7.5	_	dB	*1
	Output Return Loss HG	S22Ha	—	7.0	9.0	—	dB	*1
LNA	AC electrical characteristics	(Low Gain I	Mode)					
	Power Gain LG	GLa	PRXa = -20 dBm	-5.0	-3.0	-1.5	dB	*1
	Noise Figure LG	NFLa	—		3.0	5.5	dB	*1
	IIP3 +10 MHz offset LG	IIP3L1a	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz PRXa = -15 dBm Input 2 signals (f1, f2)	17.0	20.0	_	dBm	*1
	Reverse Isolation LG	ISOLa		-5.0	-3.0	-1.5	dB	*1
	Input Return Loss LG	S11La	_	7.0	9.0	_	dB	*1
	Output Return Loss LG	S22La	—	5.5	7.5		dB	*1

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Note) Vcc = 2.80 V

Ta = $25^{\circ}C\pm 2^{\circ}C$, fRXa = 869 MHz, 881.5 MHz, 894 MHz, PRXa = -30 dBm, CW unless otherwise specified. Performance based on application circuit 2 on page 11.

	D escription			Refe	rence va	alues		
	Parameter	Symbol	Conditions	Min	Тур	Max	Unit	Note
LNA	AC electrical characteristics	(High Gain	Mode)					
	Power Gain HG	GHb	—	12.0	14.0	16.0	dB	*1
	Noise Figure HG	NFHb	—	—	1.4	2.0	dB	*1,*2
	IIP3 +10 MHz offset HG	IIP3H1b	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz Input 2 signals (f1, f2)	7.5	11.5	_	dBm	*1
	IIP3 -10 MHz offset HG	IIP3H2b	f1 = fRXa - 10 MHz f2 = fRXa - 20 MHz Input 2 signals (f1, f2)	7.5	11.5		dBm	*1
	Input P1dB	IP1dBHb	—	-9.0	-5.0	—	dBm	*1
	Reverse Isolation HG	ISOHb	—	—	-22.0	-18.0	dB	*1
	Input Return Loss HG	S11Hb	—	2.5	4.0		dB	*1
	Output Return Loss HG	S22Hb	—	5.5	7.5		dB	*1
LNA	AC electrical characteristics	(Low Gain I	Mode)					
	Power Gain LG	GLb	PRXa = -20 dBm	-6.0	-4.0	-2.5	dB	*1
	Noise Figure LG	NFLb	—	—	4.0	6.5	dB	*1
	IIP3 +10 MHz offset LG	IIP3L1b	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz PRXa = –15 dBm Input 2 signals (f1, f2)	17.0	20.0	_	dBm	*1
	Reverse Isolation LG	ISOLb		-6.0	-4.0	-2.5	dB	*1
	Input Return Loss LG	S11Lb		2.5	5.0		dB	*1
	Output Return Loss LG	S22Lb	—	2.5	5.0	_	dB	*1

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Note) Vcc = 2.80 V

Ta = $25^{\circ}C\pm 2^{\circ}C$, fRXb = 440 MHz, 450 MHz, 460 MHz, PRXb = -30 dBm, CW unless otherwise specified. Performance based on application circuit 3 on page 12.

Description		0	Refe	rence va	alues		Note
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	Note
LNA AC electrical characteristics	(High Gain	Mode)					
Power Gain HG	GHc	—	14.0	16.0	18.0	dB	*1
Noise Figure HG	NFHc	_	_	1.4	2.1	dB	*1,*2
IIP3 +10 MHz offset HG	IIP3H1c	f1 = fRXb + 10 MHz f2 = fRXb + 20 MHz Input 2 signals (f1, f2)	6.5	10.0	_	dBm	*1
IIP3 –10 MHz offset HG	IIP3H2c	f1 = fRXb - 10 MHz f2 = fRXb - 20 MHz Input 2 signals (f1, f2)	6.5	10.0		dBm	*1
Input P1dB	IP1dBHc	—	-11.0	-7.0		dBm	*1
Reverse Isolation HG	ISOHc	—	_	-24.0	-20.0	dB	*1
Input Return Loss HG	S11Hc	—	5.5	7.5		dB	*1
Output Return Loss HG	S22Hc	—	5.0	7.5		dB	*1
LNA AC electrical characteristics	(Low Gain	Mode)					
Power Gain LG	GLc	PRXb = -20 dBm	-4.5	-3.0	-1.5	dB	*1
Noise Figure LG	NFLc	_	_	3.0	5.0	dB	*1
IIP3 +10 MHz offset LG	IIP3L1c	f1 = fRXb + 10 MHz f2 = fRXb + 20 MHz PRXb = -10 dBm Input 2 signals (f1, f2)	22.0	25.0		dBm	*1
Reverse Isolation LG	ISOLc	_	-4.5	-3.0	-1.5	dB	*1
Input Return Loss LG	S11Lc	-	8.5	10.0		dB	*1
Output Return Loss LG	S22Lc	—	12.0	15.0		dB	*1

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Note) Vcc = 2.65 V to 2.95 V

Ta = -20° C to 70° C, CW unless otherwise specified.

Performance based on application circuit 1 on page 11.

	Parameter		Symbol Conditions		Reference values			Note
	Faranielei	Symbol	Conditions	Min	Тур	Max	Unit	Note
DC e	electrical characteristics							
	Supply current (High Gain mode)	IccHT	Vcc current at High Gain mode No input signal	_	11.5	15.5	mA	*1
	Supply current (Low Gain mode)	IccLT	Vcc current at Low Gain mode No input signal	_	0	20	μA	*1
	CNT current (High Gain mode)	IcntHT	Current at CNT Pin Voltage at CNT Pin = 2.80 V	_	5	45	μA	*1
	CNT current (Low Gain mode)	IcntLT	Current at CNT Pin Voltage at CNT Pin = 0 V	_	0	20	μA	*1

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued)

REFERENCE VALUES FOR DESIGN (continued)

Note) Vcc = 2.65 V to 2.95 V

Ta = -20°C to 70°C, fRXa = 869 MHz, 881.5 MHz, 894 MHz, PRXa = -30 dBm, CW unless otherwise specified. Performance based on application circuit 1 on page 11.

	Deveneter	Cumhal	Conditions	Refer	ence v	alues	Unit	Nata
	Parameter	Symbol	Conditions	Min	Тур	Max	Unit	Note
LNA	AC electrical characteristics	(High Gain	Mode)					
	Power Gain HG	GHTa	_	12.0	15.0	18.0	dB	*1
	Noise Figure HG	NFHTa	_	_	1.5	2.4	dB	*1,*2
	IIP3 +10 MHz offset HG	IIP3H1Ta	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz Input 2 signals (f1, f2)	5.0	10.0	_	dBm	*1
	IIP3 –10 MHz offset HG	IIP3H2Ta	f1 = fRXa - 10 MHz f2 = fRXa - 20 MHz Input 2 signals (f1, f2)	5.0	10.0	_	dBm	*1
	Input P1dB	IP1dBHTa	_	-15.0	-6.0		dBm	*1
LNA	AC electrical characteristics	(Low Gain I	Mode)					
	Power Gain LG	GLTa	PRXa = – 20 dBm	-5.5	-3.0	-1.0	dB	*1
	Noise Figure LG	NFLTa	_	_	3.0	7.0	dB	*1
	IIP3 +10 MHz offset LG	IIP3LT1a	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz PRXa = - 15 dBm Input 2 signals (f1, f2)	15.0	20.0		dBm	*1

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued)

REFERENCE VALUES FOR DESIGN (continued)

Note) Vcc = 2.65 V to 2.95 V

 $Ta = -20^{\circ}C$ to 70°C, fRXa = 869 MHz, 881.5 MHz, 894 MHz, PRXa = -30 dBm, CW unless otherwise specified. Performance based on application circuit 2 on page 11.

	Parameter		Symbol Conditions Reference		rence v	alues	11	Note	
					Тур	Max	Unit		
LNA	NA AC electrical characteristics (High Gain Mode)								
	Power Gain HG	GHTb	_	11.0	14.0	17.0	dB	*1	
	Noise Figure HG	NFHTb	_	_	1.4	2.3	dB	*1,*2	
	IIP3 +10 MHz offset HG	IIP3H1Tb	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz Input 2 signals (f1, f2)	6.5	11.5	_	dBm	*1	
	IIP3 -10 MHz offset HG	IIP3H2Tb	f1 = fRXa – 10 MHz f2 = fRXa – 20 MHz Input 2 signals (f1, f2)	6.5	11.5	_	dBm	*1	
	Input P1dB	IP1dBHTb	_	-14.0	-5.0		dBm	*1	
LNA	AC electrical characteristics	(Low Gain I	Mode)						
	Power Gain LG	GLTb	PRXa = -20 dBm	-6.5	-4.0	-2.0	dB	*1	
	Noise Figure LG	NFLTb	_		4.0	8.0	dB	*1	
	IIP3 +10 MHz offset LG	IIP3LT1b	f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz PRXa = -15 dBm Input 2 signals (f1, f2)	15.0	20.0		dBm	*1	

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued)

REFERENCE VALUES FOR DESIGN (continued)

Note) Vcc = 2.65 V to 2.95 V

 $Ta = -20^{\circ}C$ to 70°C, fRXb = 440 MHz, 450 MHz, 460 MHz, PRXb = -30 dBm, CW unless otherwise specified. Performance based on application circuit 3 on page 12.

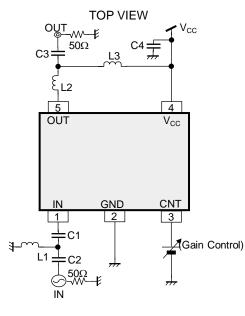
	Parameter		Conditions	Refe	Reference values			Nata
			Conditions	Min	Тур	Max	Unit	Note
LNA	AC electrical characteristics	(High Gain	Mode)					
	Power Gain HG	GHTc	_	13.0	16.0	19.0	dB	*1
	Noise Figure HG	NFHTc	_	_	1.4	2.4	dB	*1,*2
	IIP3 +10 MHz offset HG	IIP3H1Tc	f1 = fRXb + 10 MHz f2 = fRXb + 20 MHz Input 2 signals (f1, f2)	5.0	10.0	_	dBm	*1
	IIP3 –10 MHz offset HG	IIP3H2Tc	f1 = fRXb - 10 MHz f2 = fRXb - 20 MHz Input 2 signals (f1, f2)	5.0	10.0	_	dBm	*1
	Input P1dB	IP1dBHTc	_	-16.0	-7.0	_	dBm	*1
LNA	LNA AC electrical characteristics (Low Gain Mode)							
	Power Gain LG	GLTc	PRXb = -20 dBm	-5.0	-3.0	-1.0	dB	*1
	Noise Figure LG	NFLTc	_	_	3.0	6.5	dB	*1
	IIP3 +10 MHz offset LG	IIP3LT1c	f1 = fRXb + 10 MHz f2 = fRXb + 20 MHz PRXb = -10 dBm Input 2 signals (f1, f2)	20.0	25.0	_	dBm	*1

Note) *1 : Checked by design, not production tested.



APPLICATION INFORMATION (Continued) APPLICATION CIRCUIT

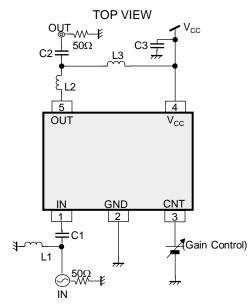
[Application Circuit 1 for 800 MHz Band]



Components	Size	Value	Part Number	Vendor
L1	0603	12 nH	LQPT03TN12NH04	Murata
L2	0603	12 nH	LQPT03TN12NH04	Murata
L3	0603	10 nH	LQPT03TN10NH04	Murata
C1	0603	1000 pF	GRM033B11C102KD01	Murata
C2	0603	4.0 pF	GJM0332C1E4R0BB01D	Murata
C3	0603	4.0 pF	GJM0332C1E4R0BB01D	Murata
C4	0603	0.1 μF	GRM033B30J104KE18	Murata

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.

[Application Circuit 2 for 800 MHz Band]

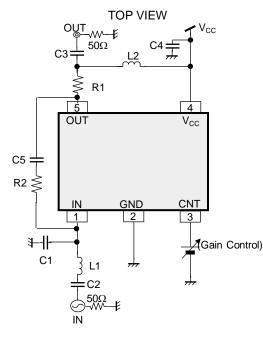


Components	Size	Value	Part Number	Vendor
L1	0603	56 nH	LQP03T56NJ04	Murata
L2	0603	12 nH	LQPT03TN12NH04	Murata
L3	0603	10 nH	LQPT03TN10NH04	Murata
C1	0603	1000 pF	GRM033B11C102KD01	Murata
C2	0603	4.0 pF	GJM0332C1E4R0BB01D	Murata
C3	0603	0.1 μF	GRM033B30J104KE18	Murata

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.

APPLICATION INFORMATION (Continued) APPLICATION CIRCUIT (Continued)

[Application Circuit 3 for 450 MHz Band]

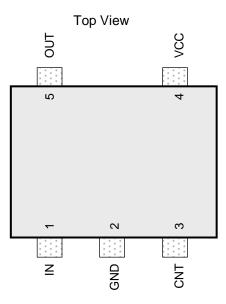


Components	Size	Value	Part Number	Vendor
L1	0603	12 nH	LQPT03TN12NH04	Murata
L2	0603	22 nH	LQP03T22NH04	Murata
R1	1005	10 Ω	ERJ2GEJ100X	Panasonic
R2	1005	1.3 kΩ	ERJ2GEJ132X	Panasonic
C1	0603	2.0 pF	GJM0334C1E2R0BB01	Murata
C2	0603	1000 pF	GRM033B11C102KD01	Murata
C3	0603	4.5 pF	GJM0332C1E4R5BB01D	Murata
C4	0603	0.1 µF	GRM033B30J104KE18	Murata
C5	1005	0.5 pF	ECJ0EC1H0R5C	Panasonic

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.



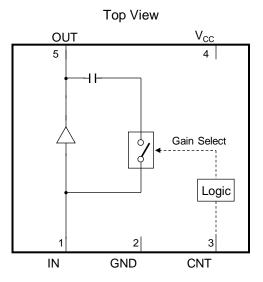
PIN CONFIGURATION



PIN FUNCTIONS

Pin No.	Pin name	Туре	Description
1	IN	Input	RF Input
2	GND	Ground	GND
3	CNT	Input	High Gain / Low Gain switch L: Low Gain Mode H: High Gain Mode
4	VCC	Power Supply	V _{cc}
5	OUT	Output	RF Output

FUNCTIONAL BLOCK DIAGRAM



Notes) This circuit and these circuit constants show an example and do not guarantee the design as a mass-production set. This block diagram is for explaining functions. The part of the block diagram may be omitted, or it may be simplified.

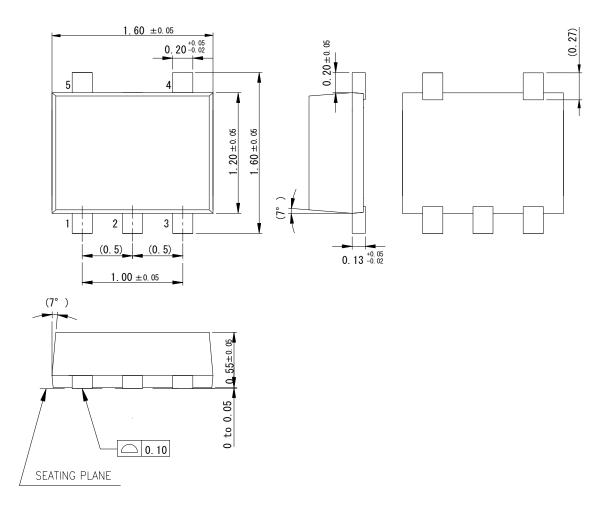
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PACKAGE INFORMATION (Reference Data)

Package Code:SSMINI-5DC

Unit:mm



Body Material	Br / Sb Free Epoxy Resin
Lead Material	: Cu Alloy
Lead Finish Meth	hod : SnBi Plating

Panasonic

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- (6) Disaster prevention and security device
- (7) Weapon

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USAGE NOTES

 When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.

- 2. Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- 3. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuitboard), it might smoke or ignite.
- 4. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
- 5. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
- Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin-VCC short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short).

And, safety measures such as an installation of fuses are recommended because the extent of the abovementioned damage and smoke emission will depend on the current capability of the power supply. 单击下面可查看定价,库存,交付和生命周期等信息

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